

**Vishay Semiconductors** 

FREE

# Thyristor High Voltage, Phase Control SCR, 16 A



PRIMARY CHARACTERISTICS				
I <sub>T(AV)</sub>	10 A			
V <sub>DRM</sub> /V <sub>RRM</sub>	800 V, 1200 V			
V <sub>TM</sub>	1.4 V			
I <sub>GT</sub>	60 mA			
TJ	-40 °C to 125 °C			
Package	TO-220AB			
Circuit configuration	Single SCR			

### **FEATURES**

- Designed and qualified according to JEDEC<sup>®</sup>-JESD 47
- 125 °C max. operating junction temperature
- Material categorization: RoHS for definitions of compliance please see COMPLIANT www.vishay.com/doc?99912 HALOGEN

### APPLICATIONS

• Typical usage is in input rectification crowbar (soft start) and AC switch in motor control, UPS, welding, and battery charge

### DESCRIPTION

The VS-16TTS... high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operating up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS					
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS					
Capacitive input filter $T_A = 55$ °C, $T_J = 125$ °C, common heatsink of 1 °C/W	13.5	17	А		

MAJOR RATINGS AND CHARACTERISTICS				
PARAMETER	TEST CONDITIONS	VALUES	UNITS	
I <sub>T(AV)</sub>	Sinusoidal waveform	10	А	
I <sub>RMS</sub>		16	A	
V <sub>DRM</sub> /V <sub>RRM</sub>	Range <sup>(1)</sup>	800/1200	V	
I <sub>TSM</sub>		200	A	
V <sub>T</sub>	10 A, T <sub>J</sub> = 25 °C	1.4	V	
dV/dt		500	V/µs	
dl/dt		150	A/µs	
TJ	Range	-40 to 125	°C	

#### Note

<sup>(1)</sup> For higher voltage up to 1600 V contact factory

VOLTAGE RATINGS							
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>DRM</sub> , MAXIMUM PEAK DIRECT VOLTAGE V	I <sub>RRM</sub> ∕I <sub>DRM</sub> AT 125 °C mA				
VS-16TTS08PbF, VS-16TTS08-M3	800	800	10				
VS-16TTS12PbF, VS-16TTS12-M3	1200	1200	10				

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ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES		
FARAMETER	STMBOL		TEST CONDITIONS	TYP.	MAX.	UNITS	
Maximum average on-state current	I <sub>T(AV)</sub>	T <sub>C</sub> = 98 °C, 1	80° conduction, half sine wave	1			
Maximum RMS on-state current	I <sub>RMS</sub>			1	6	_	
Maximum peak, one-cycle,		10 ms sine p	ulse, rated V <sub>RRM</sub> applied	17	70	A	
non-repetitive surge current	I <sub>TSM</sub>	10 ms sine p	ulse, no voltage reapplied	20	00		
Maximum I <sup>2</sup> t for fusing	10 ms sine pulse, rated V <sub>RRM</sub> applied 144		14	A <sup>2</sup> s			
	1-1	10 ms sine p	200		A-5		
Maximum I <sup>2</sup> √t for fusing	l²√t	t = 0.1 to 10 r	ns, no voltage reapplied	2000		A²√s	
Maximum on-state voltage drop	$V_{TM}$	10 A, T <sub>J</sub> = 25	10 A, T <sub>J</sub> = 25 °C			V	
On-state slope resistance	r <sub>t</sub>	T 105 %O		t T <sub>1</sub> = 125 °C 24.0		l.0	mΩ
Threshold voltage	V <sub>T(TO)</sub>	1j=125 0		1.1		V	
Maximum reverse and direct leakage current	1/1	T <sub>J</sub> = 25 °C	V <sub>R</sub> = Rated V <sub>RRM</sub> /V <sub>DRM</sub>	0.5			
Maximum reverse and direct leakage current	I <sub>RM</sub> /I <sub>DM</sub>	T <sub>J</sub> = 125 °C	VR = nated VRRM/ VDRM	10			
Holding current	Ι <sub>Η</sub>	Anode supply = 6 V, resistive load, initial $I_T$ = 1 A 16TTS08PbF, 16TTS12PbF, $T_J$ = 25 °C		-	150	mA	
Maximum latching current	١ <sub>L</sub>	Anode supply = 6 V, resistive load, $T_J$ = 25 °C		20	00	]	
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J max.$ , linear to 80 °C, $V_{DRM} = R_g - k = Open$		$^{\circ}$ C, V <sub>DRM</sub> = R <sub>g</sub> - k = Open 500		V/µs	
Maximum rate of rise of turned-on current	dl/dt			150		50	A/µs

TRIGGERING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum peak gate power	P <sub>GM</sub>		8.0	W	
Maximum average gate power	P <sub>G(AV)</sub>		2.0	vv	
Maximum peak positive gate current	+ I <sub>GM</sub>		1.5	А	
Maximum peak negative gate voltage	- V <sub>GM</sub>		10	V	
	I <sub>GT</sub>	Anode supply = 6 V, resistive load, $T_J$ = - 65 °C	90	mA	
Maximum required DC gate current to trigger		Anode supply = 6 V, resistive load, $T_J$ = 25 °C	60		
		Anode supply = 6 V, resistive load, $T_J$ = 125 °C	35		
		Anode supply = 6 V, resistive load, $T_J = -65 \ ^{\circ}C$	3.0		
Maximum required DC gate voltage to trigger	$V_{GT}$	Anode supply = 6 V, resistive load, $T_J = 25 \degree C$	2.0	V	
volage to trigger		Anode supply = 6 V, resistive load, $T_J$ = 125 °C	1.0	v	
Maximum DC gate voltage not to trigger	V <sub>GD</sub>	$T = 125 \circ C M$ = Poted value	0.25		
Maximum DC gate current not to trigger	I <sub>GD</sub>	T <sub>J</sub> = 125 °C, V <sub>DRM</sub> = Rated value	2.0	mA	

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Typical turn-on time	t <sub>gt</sub>	T <sub>J</sub> = 25 °C	0.9	
Typical reverse recovery time	t <sub>rr</sub>	T <sub>.1</sub> = 125 °C	4	μs
Typical turn-off time	tq	1j = 125 C	110	

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THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range		TJ, T <sub>Stg</sub>		-40 to 125	°C
Maximum thermal resistance, junction to case		R <sub>thJC</sub>	DC operation	1.3	
Maximum thermal resistance, junction to ambient		R <sub>thJA</sub>		62	°C/W
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	Mounting surface, smooth and greased	0.5	
Approximate weight				2	g
Approximate weight				0.07	oz.
Mounting torque	minimum			6 (5)	kgf ⋅ cm
	maximum			12 (10)	(lbf ⋅ in)
Marking davias			Case style TO 220AB	16TTS08	
Marking device			Case style TO-220AB		S12

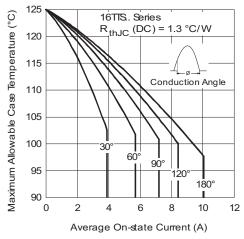
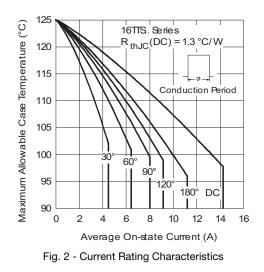


Fig. 1 - Current Rating Characteristics



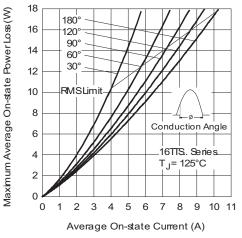


Fig. 3 - On-State Power Loss Characteristics

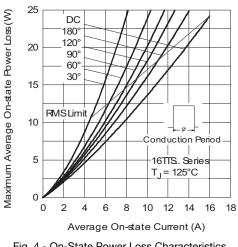


Fig. 4 - On-State Power Loss Characteristics

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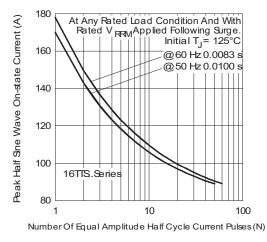


Fig. 5 - Maximum Non-Repetitive Surge Current

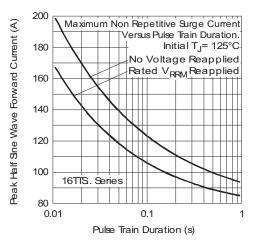


Fig. 6 - Maximum Non-Repetitive Surge Current

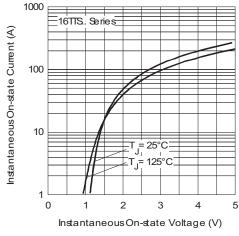


Fig. 7 - On-State Voltage Drop Characteristics

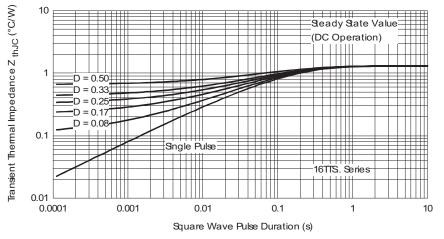


Fig. 8 - Thermal Impedance Z<sub>thJC</sub> Characteristics

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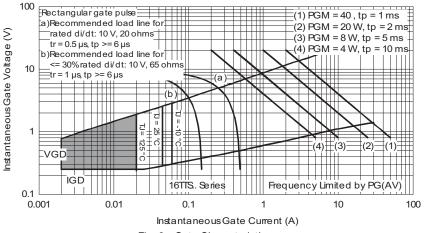


Fig. 9 - Gate Characteristics

### **ORDERING INFORMATION TABLE**

Device code	VS-	16	т	т	S	12	PbF
		(2)	(3)	(4)	(5)	(6)	(7)
		$\bigcirc$	$\bigcirc$	$\bigcirc$	0	$\bigcirc$	$\bigcirc$
	1 · 2 ·		rent rati	niconduc ng	lors pro	auct	
	3 -			guration	1:		
	_	T =	Single t	hyristor			
	4 -		kage:				
	5 -		TO-220 e of silic				
				ter grade	e	Г	
	6 -	Volt	age coc	le x 100	= V <sub>RRM</sub>		08 = 80 12 = 12
	7 -	Env	ronmen	tal digit:		L	
				(Pb)-fre			-
		-M3	= Halog	jen-free,	RoHS	complia	nt, and

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-16TTS08PbF	50	1000	Antistatic plastic tubes			
VS-16TTS08-M3	50	1000	Antistatic plastic tubes			
VS-16TTS12PbF	50	1000	Antistatic plastic tubes			
VS-16TTS12-M3	50	1000	Antistatic plastic tubes			

LINKS TO RELATED DOCUMENTS				
Dimensions		www.vishay.com/doc?95222		
Daut variation information	TO-220AB PbF	www.vishay.com/doc?95225		
Part marking information	TO-220AB -M3	www.vishay.com/doc?95028		

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**TO-220AB** 

### **DIMENSIONS** in millimeters and inches





.ead	assignments

**Diodes** 

1. - Anode/open 2. - Cathode 3. - Anode

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	NUTES
А	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
С	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6

#### Notes

- <sup>(1)</sup> Dimensioning and tolerancing as per ASME Y14.5M-1994
- <sup>(2)</sup> Lead dimension and finish uncontrolled in L1
- <sup>(3)</sup> Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- $^{\left( 4\right) }$  Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1

MILLIMETERS INCHES SYMBOL NOTES MIN. MAX. MIN. MAX. 10.51 0.414 10.11 0.398 3,6 Е E1 6.86 8.89 0.270 0.350 6 E2 0.76 0.030 7 --2.41 2.67 0.095 0.105 е 0.208 e1 4.88 5.28 0.192 H1 6.09 6.48 0.240 0.255 6,7 13.52 14.02 0.532 0.552 L L1 3.32 3.82 0.131 0.150 2 ØΡ 3.54 3.73 0.139 0.147 2.60 0.102 Q 3.00 0.118 90° to 93° 90° to 93° θ

Conforms to JEDEC outline TO-220AB

- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline



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